

## **SOLDER CONNECTION**

Email: sales@solderconnection.co.uk | Tel: +44(0)1291 624 400



### Delta RA300 60/40 Rosin Activated Solder Wire

#### DESCRIPTION

RA300 60/40 contains a rosin activated core which has extremely rapid wetting action and excellent flowing properties. RA300 residues are non-corrosive and electrically non-conductive. RA300 conforms to IPC-J-STD-004B specifications

#### FEATURES AND BENEFITS

- Excellent wettability and solder flow
- Non-corrosive, non-conductive residues

#### FEATURES AND BENEFITS

Flux Classification Softening Point	Specification ROM1 80 °C	<b>Test Method</b> J-STD-004
Copper Mirror	Partial removal of copper film	IPC-TM-650 2.3.32
Corrosion	Pass	IPC-TM-650 2.6.15
SIR		
JSTD-004, Pattern Down	$1.62 \times 10^{10}$	IPC-TM-650 2.6.3.3
Electromigration	Pass	Bellcore GR-78-CORE 13.1.4
Post Reflow Flux Residue Acid	60%	TGA Analysis
Value (mgKOH//g)	140 - 160	IPC-TM-650 2.3.13
Flux Residue Dryness	Pass	IPC-TM-650 2.4.47
Spitting of Flux-Cored Solder	0.3%	IPC-TM-650 2.4.48
Solder Spread	100 mm <sup>2</sup>	IPC-TM-650 2.4.46

#### WIRE DIAMETER

Delta Solder Wire RA300 60/40 is available in a variety of diameters. The chosen diameter is based on application methods, pad size, and desired solder joint volume. Generally, the diameter of the wire should be slightly larger than the width/diameter of the joint or connection to be soldered. Below is a list of standard diameters.

Diamter/Inch Diameter/mm	0.125 3.18	0.092 2.33	0.062 1.57	0.050 1.27	0.040 1.01	0.032 0.81	0.028	0.025 0.63	0.020 0.51	0.015 0.38
Std.Wire	11	13	16	18	19	21	22	23	25	28
Gauge	. /₋0.006	. /₋0.005	. /₋0 003	ı /-0 002	ı/-0 002	ı /-n nn2	ı /-n nn2	<b>⊥/-</b> 0 002	./-0 002	ı /-O OO2

#### FLUX PERCENTAGE

Utilizes a state-of-the-art automatic wire extrusion and wire drawing machines to manufacture consistent solder. The introduction of flux core in the wire extrusion process involves continual monitoring of flux percentage to ensure minimal flux voids and irregular wire. Typical flux percentage for leaded solder is 1.1 - 3.3%.

#### PHYSCIAL PROPERTIES

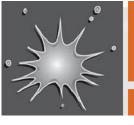
A no clean resin based core flux with alloy composition \$n60/Pb40, which is a eutectic alloy. 60/40 alloys conform to and exceed the impurity requirements of IPC-J-STD-006C.

#### STORAGE & SHELF LIFE

Solder wire storage should be in a 65-80 °F environment away from direct heat. We recommend using gloves when handling solder wire directly. Solder wire has an indefinite shelf life.

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#### typical analysis

Typical Analysis													
Sn	Ag	Cu	Pb	Sb	Bi	In	As	Fe	Ni	Cd	Al	Zn	Au
59.5 -60.5	0.100 Max	0.080 Max	Bal	0.200 Max	0.100 Max	0.100 Max	0.030 Max	0.020 Max	0.010 Max	0.002 Max	0.005 Max	0.003 Max	0.050 Max

	Sn60/Pb40
Melting Point, °C	183 - 188
Hardness, Brinell	16 HB
Coefficient of Thermal Expansion	23.9
Tensile Strength, kgf/cm <sup>2</sup>	535
Tensile Elongation, %	40
Density, g/cm <sup>3</sup>	8.50
Electrical Resistivity, (μΩ-cm)	15.3
Thermal Conductivity, W/m-K	49

#### FLUX RESIDUES & CLEANING

RA300 is a rosin activated formulation containing non-conductive residues, so residues do not need to be removed for typical applications. However, if residue removal is desired, please contact one of our sales offices to discuss your application.

#### DISPOSAL

RA300 60/40 solder should be disposed of in accordance with federal, state & local authority requirements.

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